

512K x 8 Static RAM

Features

- · High speed
 - $-t_{AA} = 15 \text{ ns}$
- · Low active power
 - -504 mW (max.)
- Low CMOS standby power (Commercial L version)
 - 1.8 mW (max.)
- 2.0V Data Retention (660 μW at 2.0V retention)
- Automatic power-down when deselected
- TTL-compatible inputs and outputs
- Easy memory expansion with CE and OE features

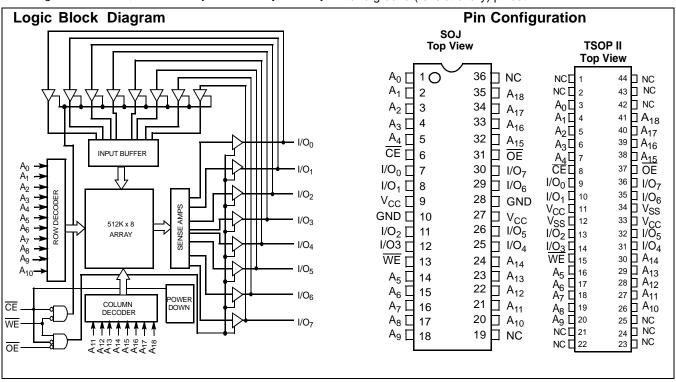
Functional Description^[1]

The CY7C1049BV33 is a high-performance CMOS Static RAM organized as 524,288 words by 8 bits. Easy memory expansion is provided by an active LOW Chip Enable (CE), an active LOW Output Enable (OE), and three-state drivers. Writing to the device is accomplished by taking Chip Enable (CE) and Write Enable (WE) inputs LOW. Data on the eight I/O pins (I/O_0) through I/O_7) is then written into the location specified on the address pins (A_0 through A_{18}).

Reading from the device is accomplished by taking Chip Enable (CE) and Output Enable (OE) LOW while forcing Write Enable (WE) HIGH. Under these conditions, the contents of the memory location specified by the address pins will appear on the I/O pins.

The eight input/output pins (I/O₀ through I/O₇) are placed in a high-impedance state when the device is deselected (CE HIGH), the outputs are disabled (OE HIGH), or during a write operation (CE LOW, and WE LOW).

The CY7C1049BV33 is available in a standard 400-mil-wide 36-pin SOJ and 44-pin TSOPII packages with center power and ground (revolutionary) pinout.



Selection Guide

CONCOUNT CONTO						
		-12	-15	-17	-20	-25
Maximum Access Time (ns)		12	15	17	20	25
Maximum Operating Current (mA) Comm		200	180	170	160	150
	Ind'l	220	200	180	170	170
Maximum CMOS Standby	Com'l/Ind	'l 8	8	8	8	8
Current (mA)	Com'l I	_ 0.5	0.5	0.5	0.5	0.5

Note:

^{1.} For guidelines on SRAM system design, please refer to the 'System Design Guidelines' Cypress application note, available on the internet at www.cypress.com.



Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.) Storage Temperature-65°C to +150°C Ambient Temperature with Power Applied-55°C to +125°C Supply Voltage on V_{CC} to Relative ${\rm GND}^{[2]}$-0.5V to +4.6V DC Voltage Applied to Outputs^[2] in High Z State-0.5V to V_{CC} + 0.5V

DC Input Voltage ^[2]	–0.5V to V _{CC} + 0.5V
Current into Outputs (LOW)	20 mA

Operating Range

Range	Ambient Temperature	v _{cc}
Commercial	0°C to +70°C	$3.3 \text{V} \pm 0.3 \text{V}$
Industrial	-40°C to +85°C	

DC Electrical Characteristics Over the Operating Range

Parame-	rame-			-	12	-	15	-	17	
ter	Description	Test Condit	Test Conditions		Max.	Min.	Max.	Min.	Max.	Unit
V _{OH}	Output HIGH Voltage	$V_{CC} = Min.,$ $I_{OH} = -4.0 \text{ mA}$		2.4		2.4		2.4		V
V _{OL}	Output LOW Voltage	V _{CC} = Min., I _{OL} = 8.0 mA			0.4		0.4		0.4	V
V _{IH}	Input HIGH Voltage				V _{CC} + 0.5	2.2	V _{CC} + 0.5	2.2	V _{CC} + 0.5	V
V _{IL}	Input LOW Voltage ^[2]			-0.5	0.8	-0.5	0.8	-0.5	0.8	V
I _{IX}	Input Load Current	$GND \le V_1 \le V_{CC}$		-1	+1	-1	+1	-1	+1	μΑ
I _{OZ}	Output Leakage Current	$\begin{array}{l} \text{GND} \leq \text{V}_{\text{OUT}} \leq \text{V}_{\text{CC}}, \\ \text{Output Disabled} \end{array}$		-1	+1	-1	+1	-1	+1	μА
I _{CC}	V _{CC} Operating	V _{CC} = Max.,	Comm'l		200		180		170	mA
	Supply Current	$f = f_{MAX} = 1/t_{RC}$	Ind'l		220		200		180	mA
I _{SB1}	Automatic CE Power-Down Current —TTL Inputs	$\begin{aligned} &\text{Max. V}_{\text{CC}}, \overline{\text{CE}} \geq \text{V}_{\text{IH}} \\ &\text{V}_{\text{IN}} \geq \text{V}_{\text{IH}} \text{or} \\ &\text{V}_{\text{IN}} \leq \text{V}_{\text{IL}}, f = f_{\text{MAX}} \end{aligned}$			30		30		30	mA
I _{SB2}	Automatic CE	Max. V _{CC} ,	Com'l/Ind'l		8		8		8	mA
			Com'l L		0.5		0.5		0.5	mA

Note:

^{2.} V_{IL} (min.) = -2.0V for pulse durations of less than 20 ns.



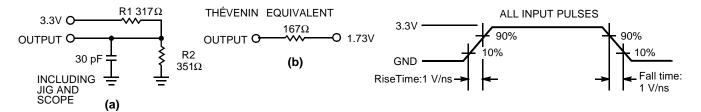
DC Electrical Characteristics Over the Operating Range (continued)

					-20		-25	
Parameter	Description	Test Conditi	ons	Min.	Max.	Min.	Max.	Unit
V _{OH}	Output HIGH Voltage	$V_{CC} = Min.,$ $I_{OH} = -4.0 \text{ mA}$		2.4		2.4		V
V _{OL}	Output LOW Voltage	V _{CC} = Min., I _{OL} = 8.0 mA			0.4		0.4	V
V _{IH}	Input HIGH Voltage			2.2	V _{CC} + 0.5	2.2	V _{CC} + 0.5	V
V _{IL}	Input LOW Voltage ^[2]			-0.5	0.8	-0.5	0.8	V
I _{IX}	Input Load Current	$GND \le V_I \le V_{CC}$		-1	+1	-1	+1	μΑ
I _{OZ}	Output Leakage Current	$\begin{array}{l} \text{GND} \leq \text{V}_{\text{OUT}} \leq \text{V}_{\text{CC}}, \\ \text{Output Disabled} \end{array}$		-1	+1	-1	+1	μΑ
I _{CC}	V _{CC} Operating	V _{CC} = Max.,	Com'l		160		150	mA
	Supply Current	$f = f_{MAX} = 1/t_{RC}$	Ind'l		170		170	mA
I _{SB1}	Automatic CE Power-Down Current —TTL Inputs	$\begin{aligned} &\text{Max. V}_{\text{CC}}, \overline{\text{CE}} \geq \text{V}_{\text{IH}} \\ &\text{V}_{\text{IN}} \geq \text{V}_{\text{IH}} \text{ or} \\ &\text{V}_{\text{IN}} \leq \text{V}_{\text{IL}}, \text{ f} = \text{f}_{\text{MAX}} \end{aligned}$			30		30	mA
I _{SB2}	Automatic CE	Max. V _{CC} ,	Com'l/Ind'l		8		8	mA
	Power-Down Current —CMOS Inputs	$\overline{CE} \ge V_{CC} - 0.3V,$ $V_{IN} \ge V_{CC} - 0.3V,$ or $V_{IN} \le 0.3V,$ f = 0	Com'l L		0.5		0.5	mA

Capacitance^[3]

Parameter	Description	Test Conditions	Max.	Unit
C _{IN}	Input Capacitance	$T_A = 25^{\circ}C$, $f = 1$ MHz,	8	pF
C _{OUT}	I/O Capacitance	$V_{CC} = 3.3V$	8	pF

AC Test Loads and Waveforms



Note

3. Tested initially and after any design or process changes that may affect these parameters.



AC Switching Characteristics^[4] Over the Operating Range

		-	12		15		17	
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Unit
Read Cycle		•	•	•	•	•	•	
t _{power}	V _{CC} (typical) to the First Access ^[5]	1		1		1		μs
t _{RC}	Read Cycle Time	12		15		17		ns
t _{AA}	Address to Data Valid		12		15		17	ns
t _{OHA}	Data Hold from Address Change	3		3		3		ns
t _{ACE}	CE LOW to Data Valid		12		15		17	ns
t _{DOE}	OE LOW to Data Valid		6		7		8	ns
t _{LZOE}	OE LOW to Low Z	0		0		0		ns
t _{HZOE}	OE HIGH to High Z ^[6, 7]		6		7		8	ns
t _{LZCE}	CE LOW to Low Z ^[7]	3		3		3		ns
t _{HZCE}	CE HIGH to High Z ^[6, 7]		6		7		8	ns
t _{PU}	CE LOW to Power-Up	0		0		0		ns
t _{PD}	CE HIGH to Power-Down		12		15		17	ns
Write Cycle [[]	8, 9]							
t _{WC}	Write Cycle Time	12		15		17		ns
t _{SCE}	CE LOW to Write End	10		12		13		ns
t _{AW}	Address Set-Up to Write End	10		12		13		ns
t _{HA}	Address Hold from Write End	0		0		0		ns
t _{SA}	Address Set-Up to Write Start	0		0		0		ns
t _{PWE}	WE Pulse Width	10		12		13		ns
t _{SD}	Data Set-Up to Write End	7		8		9		ns
t _{HD}	Data Hold from Write End	0		0		0		ns
t _{LZWE}	WE HIGH to Low Z ^[7]	3		3		3		ns
t _{HZWE}	WE LOW to High Z ^[6, 7]		6		7		8	ns

Notes:

- Test conditions assume signal transition time of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V, and output loading of the specified I_{OL}/I_{OH} and 30-pF load capacitance.

 This part has a voltage regulator which steps down the voltage from 5V to 3.3V internally. T., power time has to be provided initially before a read/write operation

- It started.

 \$\text{t}_{\text{LZCE}}\$, \$\tex



$\begin{tabular}{ll} \textbf{AC Switching Characteristics} \end{tabular} It is a proper than the operating Range (continued) and the operating Range (continued) are the operating Range (continued) and the operating Range (continued) are the operating Range (continued) and the operating Range (continued) are the operating Range (continued) and the operating Range (continued) are the operation of the operating Range (continued) are the operation of the o$

		-2	20	-2	25	
Parameter	Description	Min.	Max.	Min.	Max.	Unit
Read Cycle		•	•	•		
t _{power}	V _{CC} (typical) to the First Access ^[6]	1		1		μs
t _{RC}	Read Cycle Time	20		25		ns
t _{AA}	Address to Data Valid		20		25	ns
t _{OHA}	Data Hold from Address Change	3		3		ns
t _{ACE}	CE LOW to Data Valid		20		25	ns
t _{DOE}	OE LOW to Data Valid		8		10	ns
t _{LZOE}	OE LOW to Low Z	0		0		ns
t _{HZOE}	OE HIGH to High Z ^[6, 7]		8		10	ns
t _{LZCE}	CE LOW to Low Z ^[7]	3		3		ns
t _{HZCE}	CE HIGH to High Z ^[6, 7]		8		10	ns
t _{PU}	CE LOW to Power-Up	0		0		ns
t _{PD}	CE HIGH to Power-Down		20		25	ns
Write Cycle ^{[§}	9]	·				
t _{WC}	Write Cycle Time	20		25		ns
t _{SCE}	CE LOW to Write End	13		15		ns
t _{AW}	Address Set-Up to Write End	13		15		ns
t _{HA}	Address Hold from Write End	0		0		ns
t _{SA}	Address Set-Up to Write Start	0		0		ns
t _{PWE}	WE Pulse Width	13		15		ns
t _{SD}	Data Set-Up to Write End	9		10		ns
t _{HD}	Data Hold from Write End	0		0		ns
t _{LZWE}	WE HIGH to Low Z ^[7]	3		3		ns
t _{HZWE}	WE LOW to High Z ^[6, 7]		8		10	ns

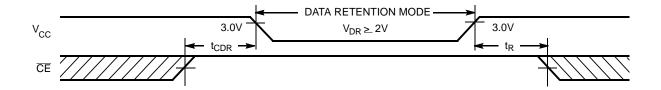
Data Retention Characteristics Over the Operating Range (For L version only)

Parameter	Description	Conditions ^[10]	Min.	Max	Unit
V_{DR}	V _{CC} for Data Retention		2.0		V
I _{CCDR}	Data Retention Current	$\frac{V_{CC}}{CE} = V_{DR} = 2.0V,$ $CE \ge V_{CC} - 0.3V$		330	μΑ
t _{CDR} ^[3]	Chip Deselect to Data Retention Time	$V_{IN} \ge V_{CC} - 0.3V$ $V_{IN} \ge V_{CC} - 0.3V$ or $V_{IN} \le 0.3V$	0		ns
t _R ^[11]	Operation Recovery Time		t _{RC}		ns

^{10.} No input may exceed V_{CC} + 0.5V 11. $t_r \le 3$ ns for the -12 and -15 speeds. $t_r \le 5$ ns for the -20 ns and slower speeds.

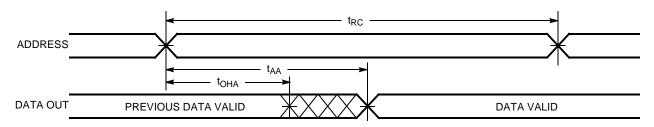


Data Retention Waveform

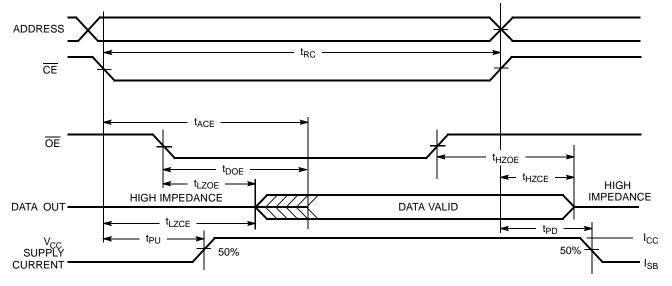


Switching Waveforms

Read Cycle No. 1^[12, 13]



Read Cycle No. 2 ($\overline{\text{OE}}$ Controlled)[13, 14]



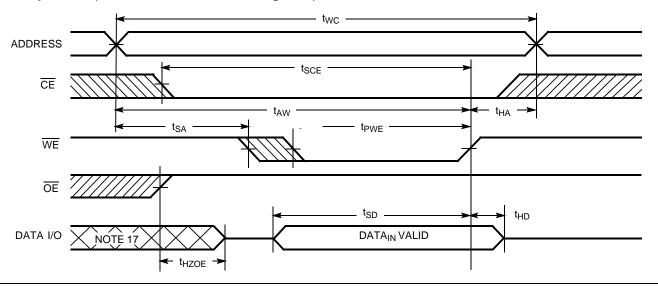
Notes:

- Device is continuously selected. OE, CE = V_{IL}.
 WE is HIGH for read cycle.
 Address valid prior to or coincident with CE transition LOW.

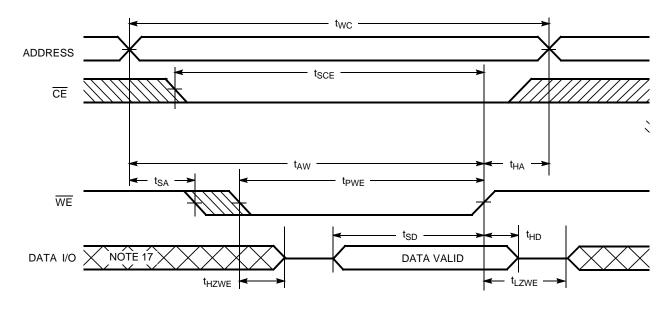


Switching Waveforms (continued)

Write Cycle No. 1(WE Controlled, OE HIGH During Write)[15, 16]



Write Cycle No. 2 (WE Controlled, OE LOW)[16]



Truth Table

CE	OE	WE	I/O ₀ – I/O ₇	Mode	Power
Н	Х	Х	High Z	Power-Down	Standby (I _{SB})
L	L	Н	Data Out	Read	Active (I _{CC})
L	Х	L	Data In	Write	Active (I _{CC})
L	Н	Н	High Z	Selected, Outputs Disabled	Active (I _{CC})

Notes:

- Data I/O is high-impedance if OE = V_{IH}.
 If CE goes HIGH simultaneously with WE going HIGH, the output remains in a high-impedance state.
 During this period the I/Os are in the output state and input signals should not be applied.



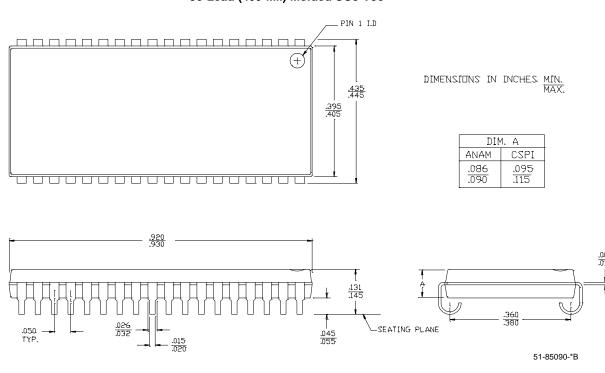
Ordering Information

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
12	CY7C1049BV33-12VC	V36	36-Lead (400-Mil) Molded SOJ	Commercial
	CY7C1049BV33-12ZC	Z44	44-Pin TSOP II Z44	
	CY7C1049BV33L-12VC	V36	36-Lead (400-Mil) Molded SOJ	
	CY7C1049BV33-12VI	V36	36-Lead (400-Mil) Molded SOJ	Industrial
15	CY7C1049BV33-15VC	V36	36-Lead (400-Mil) Molded SOJ	Commercial
	CY7C1049BV33L-15VC	V36	36-Lead (400-Mil) Molded SOJ	
	CY7C1049BV33-15ZC	Z44	44-Pin TSOP II Z44	
	CY7C1049BV33L-15ZC	Z44	44-Pin TSOP II Z44	
	CY7C1049BV33-15VI	V36	36-Lead (400-Mil) Molded SOJ	Industrial
	CY7C1049BV33-15ZI	Z44	44-Pin TSOP II Z44	
17	CY7C1049BV33-17VC	V36	36-Lead (400-Mil) Molded SOJ	Commercial
	CY7C1049BV33L-17VC	V36	36-Lead (400-Mil) Molded SOJ	
	CY7C1049BV33-17ZC	Z44	44-Pin TSOP II Z44	
	CY7C1049BV33L-17ZC	Z44	44-Pin TSOP II Z44	
	CY7C1049BV33-17VI	V36	36-Lead (400-Mil) Molded SOJ	Industrial
	CY7C1049BV33L-17VI	V36	36-Lead (400-Mil) Molded SOJ	
	CY7C1049BV33-17ZI	Z44	44-Pin TSOP II Z44	
20	CY7C1049BV33-20VC	V36	36-Lead (400-Mil) Molded SOJ	Commercial
	CY7C1049BV33L-20VC	V36	36-Lead (400-Mil) Molded SOJ	
	CY7C1049BV33-20ZC	Z44	44-Pin TSOP II Z44	
	CY7C1049BV33L-20ZC	Z44	44-Pin TSOP II Z44	
	CY7C1049BV33-20VI	V36	36-Lead (400-Mil) Molded SOJ	Industrial
	CY7C1049BV33-20ZI	Z44	44-Pin TSOP II Z44	
25	CY7C1049BV33-25VC	V36	36-Lead (400-Mil) Molded SOJ	Commercial
	CY7C1049BV33L-25VC	V36	36-Lead (400-Mil) Molded SOJ	
	CY7C1049BV33-25ZC	Z44	44-Pin TSOP II Z44	
	CY7C1049BV33L-25ZC	Z44	44-Pin TSOP II Z44	
	CY7C1049BV33-25VI	v36	36-Lead (400-Mil) Molded SOJ	Industrial
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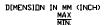


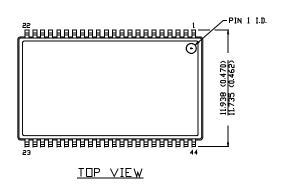
Package Diagrams

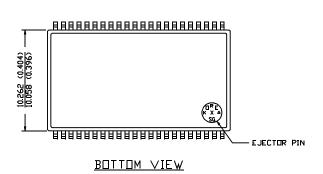
36-Lead (400-Mil) Molded SOJ V36

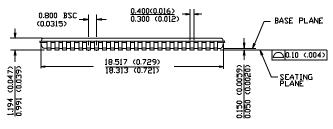


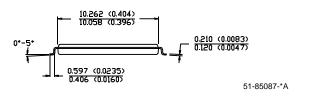












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